

1 DESCRIPTION

UNIMEC H9890-6A is a low-temperature sintered die attach paste using our Metallo-Organic (MO) technology. This high thermal conductive paste does not require pressure while curing, and the fragile, porous sintered structure has been reinforced by our proprietary resin system. This material has been developed for replacing eutectic solders offering the same thermal performance as AuSn solder.

3 KEY FEATURES

- High thermal and electrical performance.
- Controllable BLT to 10µm or more.
- Strong adhesion to metalized surfaces (Au or Ag).
- Low bleeding and extended pot life.
- Formulated for longer open and staging time.

4 TYPICAL PROPERTIES

2 APPLICATIONS

- IGBT for Motor Control
- HBLED (High Brightness LEDs)
- Power Amplifiers for RF & Microwave
- Power semiconductors
- Laser diodes
- RF Power devices
- GaAs devices
- MMICs
- Power hybrids
- Solder replacement

Parameter		Unit	Note / Condition
PASTE PROPERTIES (before curing)			
Viscosity	30	Pas	Viscometer type EHD 3° Cone R9.7 (25°C) @5rpm
Thixotropic index	7.0	--	0.5 rpm / 5 rpm
Non-volatiles content	91	%	
Density	4.2	g/cc	Calculated
CURED PROPERTIES (60 min. ramp to 200C, and 60 min. hold at 200°C)			
Volume resistivity	8	µΩcm	LCR Meter
Die Shear strength	RT	50	Si chip (2x2mm, backside Au)/ Ag plated CuLF
	@260°C	25	
Coefficient of Thermal Expansion (CTE)	23	ppm/°C	TMA
Water Absorption	< 0.1	%	After 96 hours at 85°C 85% RH exposure
Storage Modulus	RT	17	DMA
	200°C	8.2	
Impurities concentration	Na	< 5	NATS
	K	< 5	
	Cl	< 15	
Thermal conductivity	1 layer	140	Laser Flash, 0.7 mm thickness Laser Flash, BLT 35 µm thickness
	3 layer	120	
Silver content	87	%	Calculated
Thermal Resistance	0.3	K/W	JEDEC JESD51-1 static test method (T3Ster, 3x3mm Si chip (backside: Au)/Ag plated Al ₂ O ₃)
SYRINGE PROPERTIES			
Pot Life	2	days	25% increase in viscosity @ 5rpm @ 25°C

5 DIE SHEAR STRENGTH

Substrate Surface	@ RT	@ 260°C
Ag Plated	50 N/mm ²	31 N/mm ²
Ni/Pd/Au Plated	49 N/mm ²	30 N/mm ²
Bare Cu	48 N/mm ²	31 N/mm ²

6 STORAGE AND HANDLING

- Store in a freezer -40 °C or below.
- Shelf life 12 months from date of manufacture.
- Bring the material to room temperature before use.
- Wear gloves when handling product.
- Clean contaminated skin with soap and water immediately.

7 PROCESSING GUIDELINES

- Application method: Dispensing
- Curing Conditions: Ramp up 60 min. to 200°C + 60 min. hold @ 200°C or ramp up 60 min. to 175°C + 90 min. hold @ 175°C.
- Can be used with standard pneumatic or auger dispense equipment.

10 MORE INFORMATION

For more information on H9890-6A and other NAMICS products contact your local NAMICS sales office below:

NAMICS Corporation, 3993 Nigorikawa, Kita-ku, Niigata City, 950-3131, Japan

Phone +81-25-258-5577 Fax +81-25-258-5511 www.namics.co.jp

NAMICS Technologies, Inc. 2055 Gateway Place, Suite 480, San Jose, CA 95110, USA

Phone +1-408-516-4611 Fax +1-408-516-4617 sales@namics-usa.com

NAMICS Europe GmbH, Max Emanuel Platz 1, 85764 Oberschleissheim b., München, Germany

Phone +49-89-36036-730 Fax +49-89-36036-700 info@namics-europe.com

Singapore NAMICS Company Pte. Ltd., 1 Yishun Industrial Street 1 A'Posh Bizhub #06-25, Singapore, 768160

Phone +65-6747-3757 Fax +65-6747-0721 sales@namics-asia.com

Taiwan NAMICS Electronics Co., Ltd., Rm. 3, 10F., No. 360, Sec. 2, Taiwan Blvd, North Dist., Taichung City 40453, Taiwan (R.O.C.)

Phone +886-4-2329-2158 Fax +886-4-2329-2155 sales@namics-tw.com

KOREA NAMICS Co., LTD, 7F Kookmin 2 Bldg, 1008-2 Daechi-dong Gangnam-gu, Seoul Korea, 135-851

Phone +82-02-562-2812 Fax +82-02-562-2814 sales@namics-kr.com

SHANGHAI NAMICS Co., LTD., Room 516, No. 38, Yinglun Road, Waigaoqiao, Free Trade Zone, Shanghai, P.R.C. 200131

Phone +86-21-20246358 Fax +86-21-20247808 sales@namics-cn.com

www.namics.co.jp

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8 OPEN AND STAGING TIME INFORMATION

- Open time is the time between applying adhesive and placing die.
H9890-6A has an open time of 24 hours.
- Staging time is the time between die placement and curing.
H9890-6A has a staging time of 48 hours.

The following table shows the time needed to thaw the syringes of each size:

Syringe Size	-40°C Storage Condition
5cc, 10g syringe	1 to 1.5 hours
10cc, 15g syringe	1 to 1.5 hours

9 ORDERING INFORMATION

Ordering Number	Key Product Characteristics
UNIMEC H9890-6A	High thermal & electrical performance
<ul style="list-style-type: none">■ Available in syringes only.■ Standard syringe sizes and fill amounts are 5cc filled with 10 grams, and 10cc filled with 15 grams.■ Contact your local NAMICS office below.	